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Vishay/Siliconix SI7440DP-T1-E3

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Vishay Siliconix

N-Channel 30-V (D-S) Fast Switching MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A)		
30	0.0065 at V _{GS} = 10 V	21		
	0.008 at V _{GS} = 4.5 V	19		

FE	EATURES	
•	Halogen-free	Α

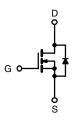
- Halogen-free According to IEC 61249-2-21 Available
- TrenchFET® Power MOSFET
- New Low Thermal Resistance PowerPAK[®] Package with Low 1.07 mm Profile
- 100 % R_q Tested





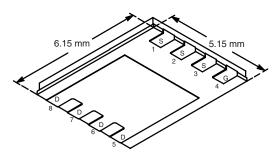
APPLICATIONS

- DC/DC Converters
- Optimized for "Low-Side" Synchronous Rectifier Operation



N-Channel MOSFET

PowerPAK SO-8



Bottom View

Ordering Information: Si7440DP-T1-E3 (Lead (Pb)-free)

Si7440DP-T1-GE3 (Lead (Pb)-free and Halogen-free)

Parameter		Symbol	10 s	Steady State	Unit	
Drain-Source Voltage		V_{DS}	30		V	
Gate-Source Voltage		V_{GS}	± 20			
Continuous Drain Current (T _{.I} = 150°C) ^a	T _A = 25°C	- I _D	21	12	۸	
Continuous Diam Current (1) = 150 C)	T _A = 70°C		17	9		
Pulsed Drain Current		I _{DM}	60		Α	
Continuous Source Current (Diode Conduction) ^a		I _S	4.3	1.6		
Maximum Power Dissipation ^a	T _A = 25°C	P _D	5.4	1.9	W	
Maximum Fower Dissipation	T _A = 70°C		3.4	1.2		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150		°C	
Soldering Recommendations (Peak Temperature) ^{b, c}		Ŭ	260			

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^a	t ≤ 10 s	- R _{thJA}	18	23	°C/W	
Maximum Junction-to-Ambient*	Steady State		52	65		
Maximum Junction-to-Case (Drain)	Steady State	R _{thJC}	1.0	1.3		

Notes

- a. Surface Mounted on 1" x 1" FR4 board.
- b. See Solder Profile (<u>www.vishay.com/ppg?73257</u>). The PowerPAK SO-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- c. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.

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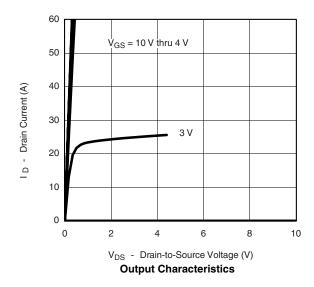


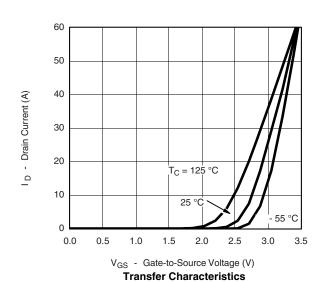
rameter Symbol		Test Conditions	Min.	Тур.	Max.	Unit
Static				•		
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \mu A$	1.0		3.0	V
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 30 V, V _{GS} = 0 V	V _{DS} = 30 V, V _{GS} = 0 V		1	μΑ
		V _{DS} = 30 V, V _{GS} = 0 V, T _J = 55°C			5	
On-State Drain Current ^a	te Drain Current ^a I _{D(on)}		40			Α
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 10 \text{ V}, I_D = 21 \text{ A}$		0.0053	0.0065	-
		V _{GS} = 4.5 V, I _D = 19 A		0.0065	0.008	Ω
Forward Transconductance ^a	g_{fs} $V_{DS} = 15 \text{ V}, I_D = 21 \text{ A}$			65		S
Diode Forward Voltage ^a	V _{SD}	$I_S = 4.3 \text{ A}, V_{GS} = 0 \text{ V}$		0.72	1.2	V
Dynamic ^b						
Total Gate Charge	Q_g			29.0	35	nC
Gate-Source Charge	Q_{gs}	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 21 \text{ A}$		10.5		
Gate-Drain Charge	Q _{gd}			10.0		
Gate Resistance	R_{g}		0.5	1.4	2.2	Ω
Turn-On Delay Time	t _{d(on)}			18	28	
Rise Time	t _r			16	25	
Turn-Off Delay Time	$t_{d(off)}$ $I_D \cong 1.0 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 6 \Omega$		75	180	ns	
Fall Time	t _f			41	65	- 115
Source-Drain Reverse Recovery Time	t _{rr}	$I_F = 4.3 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}$		50	80	

- a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %. b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





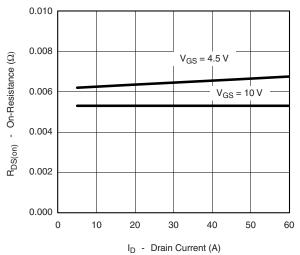
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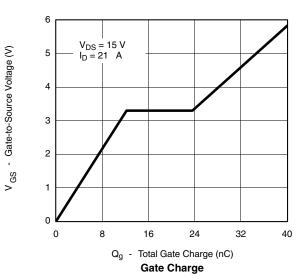


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On-Resistance vs. Drain Current



T_J = 150 °C

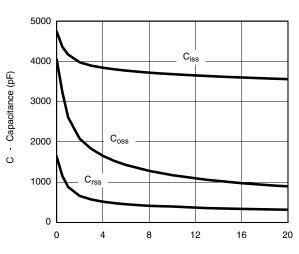
T_J = 150 °C

T_J = 25 °C

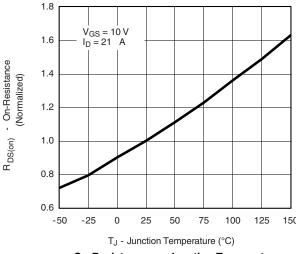
T_J = 25 °C

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0.0 0.2 0.4 0.6 0.8 1.0 1.2

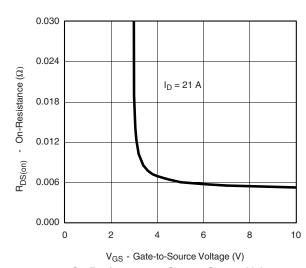
 V_{SD} - Source-to-Drain Voltage (V) **Source-Drain Diode Forward Voltage**



V_{DS} - Drain-to-Source Voltage (V) **Capacitance**



On-Resistance vs. Junction Temperature



On-Resistance vs. Gate-to-Source Voltage

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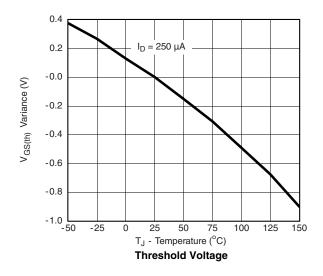
s - Source Current (A)

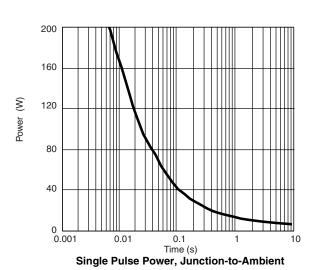


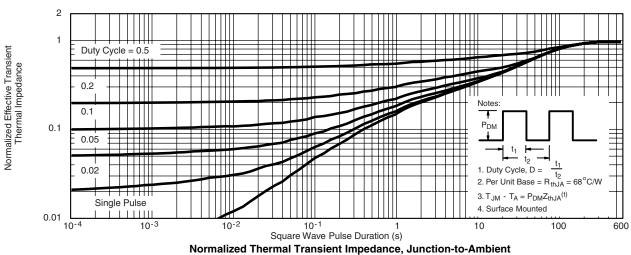
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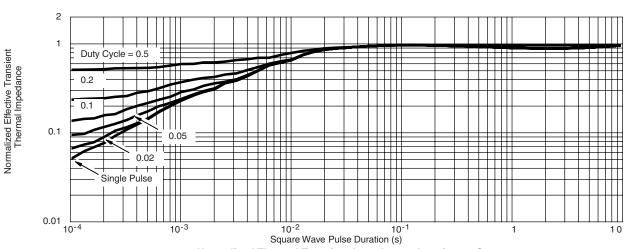


TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted









Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?71623.

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Distributor of Vishay/Siliconix: Excellent Integrated System Limited

Datasheet of SI7440DP-T1-E3 - MOSFET N-CH 30V 12A PPAK SO-8

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com



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